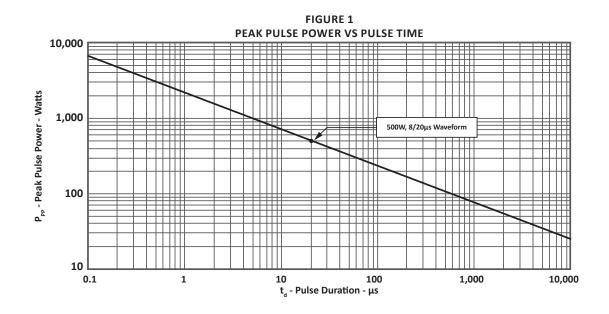
## **TYPICAL DEVICE CHARACTERISTICS**

05102

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified							
PARAMETER SYMBOL VALUE UNITS							
Operating Temperature	Τ <sub>ι</sub>	-55 to 150	°C				
Storage Temperature	T <sub>stg</sub>	-55 to 150	°C				
Peak Pulse Power (tp = 8/20µs) - See Figure 1	P <sub>pp</sub>	500	Watts				

PART NUMBER	DEVICE MARKING	RATED STAND-OFF VOLTAGE	MINIMUM BREAKDOWN VOLTAGE	MAXIMUM CLAMPING VOLTAGE (Fig. 2)	MAXIMUM LEAKAGE CURRENT	MAXIMUM CAPACITANCI (Note 1)
		V <sub>WM</sub> VOLTS	@1mA V <sub>(BR)</sub> VOLTS	@I <sub>p</sub> = 1A V <sub>c</sub> VOLTS	@V <sub>wm</sub> Ι <sub>D</sub> μΑ	@0V, 1MHz C pF
PLCDA03C-6	PRS	3.3	4.5	7.0	125	8
PLCDA05C-6	PRT	5.0	6.0	9.8	20	8
PLCDA08C-6	PRW	8.0	8.5	13.4	10	8
PLCDA12C-6	PRV	12.0	13.3	19.0	2	8
PLCDA15C-6	PRU	15.0	16.7	24.0	2	8

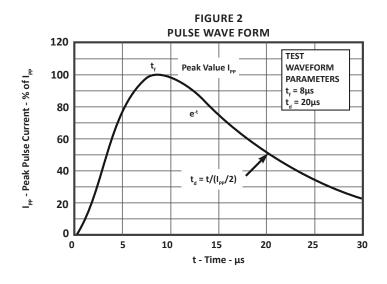
Lapa between I/O pir id (pins 4 and 5) is typically 8pF. Capacitance between I/O pins is typically 4pF. gı

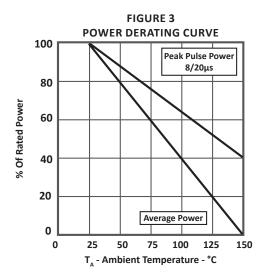


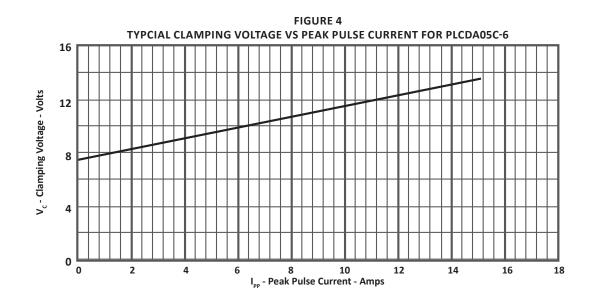
# 

# PLCDA03C-6 - PLCDA15C-6

### **TYPICAL DEVICE CHARACTERISTICS**





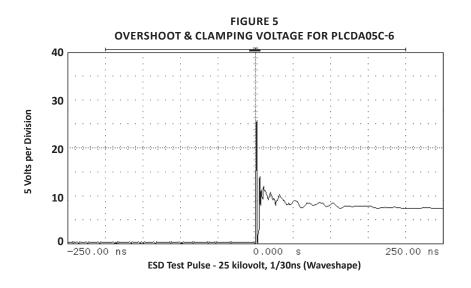


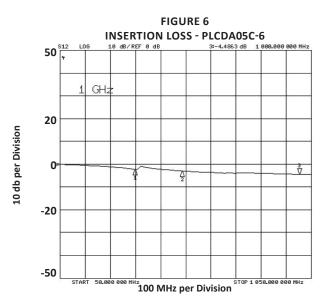
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## **TYPICAL DEVICE CHARACTERISTICS**

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**FIGURE 7 RETURN LOSS - PLCDA05C-6** 50 [<u>.</u> 367.700 012 MHz REF Ø d 2:-15.579 dB 367.700012 MHz 20 10 db per Division **0**° A 3 ₩ -20 -50 START TOP 1 050.000 000 MHz 58.88 100 MHz per Division

## 

## SPICE MODEL

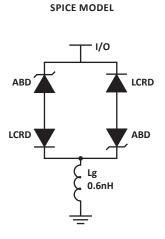


FIGURE 1

ABD - Avalanche Breakdown Diode (TVS) LCRD: Low Capacitance Rectifier Diode Lg - Lead Inductance

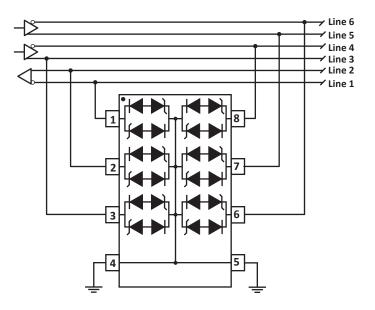
TABLE 1 - SPICE PARAMETERS								
PARAMETER	UNIT	ABD(TVS)	LCRD					
BV	V	See Table 2	200					
IBV	μΑ	1	0.01					
C <sub>jo</sub>	pF	See Table 2	5					
۱ <sub>s</sub>	А	See Table 2	1E-13					
Vj	V	0.6	0.6					
м	-	0.33	0.33					
N	-	1	1					
R <sub>s</sub>	Ohms	See Table 2	0.31					
TT	S	1E-8	1E-9					
EG	eV	1.11	1.11					

TABLE 2 - ABD SPECIFIC SPICE PARAMETERS								
PART NUMBER	B <sub>v</sub> (VOLTS)	C <sub>io</sub> (pF)	I <sub>s</sub> (AMPS)	Rs(OHMS)				
PLCDA03	4.5	438	1E-11	0.21				
PLCDA05	6.0	284	1E-11	0.14				
PLCDA15	16.7	102	1E-13	0.52				

## APPLICATION INFORMATION

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#### FIGURE 1 - BIDIRECTIONAL COMMON-MODE PROTECTION FOR A TRANSCEIVER

- Circuit connectivity is as follows:
- Line 1 connected to Pin 1.
- Line 2 connected to Pin 2.
- Line 3 connected to Pin 3.
- Line 4 connected to Pin 8.
- Line 5 connected to Pin 7.
- Line 6 connected to Pin 6.
- Pins 4 and 5 connected to ground.

## **CIRCUIT BOARD RECOMMENDATIONS**

Circuit board layout is critical for electromagnetic compatibility protection. The following guidelines are recommended:

- The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- The path length between the TVS device and the protected line should be minimized.
- All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

## **SO-8 PACKAGE INFORMATION**

OUTLINE DIMENSIONS								
DIM	MILLIN	IETERS	INCHES					
DIIVI	MIN	MAX	MIN	MAX				
А	4.80	5.00	0.189	0.196				
В	3.80	4.00	0.150	0.157				
С	1.35	1.75	0.054	0.068				
D	0.35	0.49	0.014	0.019				
F	0.40	1.25	0.016	0.049				
G	1.27	BSC	0.05	BSC				
J	0.18	0.25	0.007	0.009				
К	0.10	0.25	0.004	0.008				
Р	5.80	6.20	0.229	0.244				
R	0.25	0.50	0.010	0.019				
· · · · · · · · · · · · · · · · · · ·								



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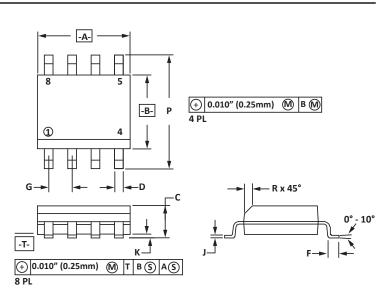
1. -T- = Seating plane and datum surface.

2. Dimensions "A" and "B" are datum.

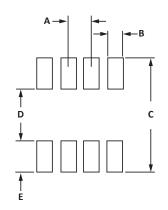
3. Dimensions "A" and "B" do not include mold protrusion.

Maximum mold protrusion is 0.015" (0.380mm) per side.
Dimensioning and tolerances per ANSI Y14.5M, 1982.

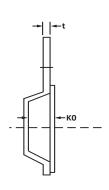
Dimensions are exclusive of mold flash and metal burrs.

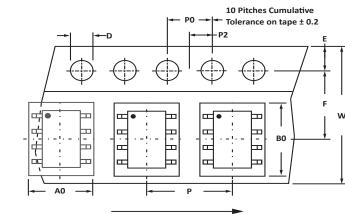


PAD LAYOUT DIMENSIONS								
DIM	MILLIN	IETERS	INCHES					
	MIN	MAX	MIN	MAX				
А	1.14	1.40	0.045	0.055				
В	0.64	0.89	0.025	0.035				
С	6.22	6.22 -		-				
D	3.94	4.17	0.155	0.165				
E	E 1.02 1.27 0.040 0.050							
NOTES 1. Cont	rolling dimensior	n: inches.						



## TAPE AND REEL





User Direction of Feed

SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	В0	КО	D	E	F	w	PO	P2	Р	tmax
178mm (7")	12mm	6.50 ± 0.10	$5.40 \pm 0.10$	$2.00 \pm 0.10$	$1.50 \pm 0.10$	1.75 ± 0.10	5.50 ± 0.05	12.00 ± 0.30	4.00 ± 0.12	2.00 ± 0.10	8.00 ± 0.10	0.25
NOTES												

<sup>1.</sup> Dimensions are in millimeters.

3. Suffix - T7 = 7'' Reel - 1,000 pieces per 12mm tape.

4. Suffix - T13 = 13" Reel - 2,500 pieces per 12mm tape.

5. Bulk product shipped in tubes of 98 pieces per tube.

6. Marking on Part - marking code (see page 2), date code, logo and pin one defined by dot on top of package.

ORDERING INFORMATION								
BASE PART NUMBER (xx = Voltage)	LEADFREE SUFFIX	TAPE SUFFIX	QTY/REEL	REEL SIZE	TUBE QTY			
PLCDAxxC-6	-LF	-T7	1,000	7"	98			
PLCDAxxC-6	-LF	-T13	2,500	13"	98			
This device is only available in	This device is only available in a Lead-Free configuration.							

<sup>2.</sup> Surface mount product is taped and reeled in accordance with EIA-481.

#### COMPANY INFORMATION

#### **COMPANY PROFILE**

In business more than 25 years, ProTek Devices<sup>™</sup> is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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